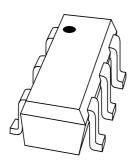
### **DISCRETE SEMICONDUCTORS**

# DATA SHEET



# PUMT1 PNP general purpose double transistor

Product specification Supersedes data of 1999 Apr 14 2001 Dec 19





## PNP general purpose double transistor

#### PUMT1

#### **FEATURES**

- Low current (max. 100 mA)
- Low voltage (max. 40 V)
- Reduces number of components and boardspace.

#### **APPLICATIONS**

• General purpose switching and amplification.

#### **DESCRIPTION**

Two independently operating PNP transistors in an SC-88; SOT363 plastic package. NPN complement: PUMX1.

#### **MARKING**

TYPE NUMBER	MARKING CODE		
PUMT1	FtF		

#### **PINNING**

PIN	DESCRIPTION		
1, 4	emitter	TR1; TR2	
2, 5	base	TR1; TR2	
3, 6	collector	TR2; TR1	

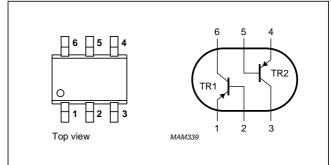


Fig.1 Simplified outline (SC-88; SOT363) and symbol.

#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	RAMETER CONDITIONS		MAX.	UNIT	
Per transist	Per transistor					
V <sub>CBO</sub>	collector-base voltage	open emitter	_	-50	V	
V <sub>CEO</sub>	collector-emitter voltage	open base	_	-40	V	
V <sub>EBO</sub>	emitter-base voltage	open collector	_	-5	V	
I <sub>C</sub>	collector current (DC)		_	-100	mA	
I <sub>CM</sub>	peak collector current		_	-200	mA	
I <sub>BM</sub>	peak base current		_	-200	mA	
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	_	200	mW	
T <sub>stg</sub>	storage temperature		-65	+150	°C	
Tj	junction temperature		_	150	°C	
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C	
Per device						
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1	_	300	mW	

#### Note

1. Device mounted on an FR4 printed-circuit board.

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#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
Per device				
R <sub>th j-a</sub>	thermal resistance from junction to ambient	note 1	416	K/W

#### Note

1. Device mounted on an FR4 printed-circuit board.

#### **CHARACTERISTICS**

 $T_{amb}$  = 25 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per transist	or				
I <sub>CBO</sub>	collector cut-off current	I <sub>E</sub> = 0; V <sub>CB</sub> = -30 V	_	-100	nA
		$I_E = 0$ ; $V_{CB} = -30 \text{ V}$ ; $T_j = 150 ^{\circ}\text{C}$	_	-10	μΑ
I <sub>EBO</sub>	emitter cut-off current	I <sub>C</sub> = 0; V <sub>EB</sub> = -4 V	_	-100	nA
h <sub>FE</sub>	DC current gain	$I_C = -1 \text{ mA}; V_{CE} = -6 \text{ V}$	120	_	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = -50 \text{ mA}$ ; $I_B = -5 \text{ mA}$ ; note 1	_	-200	mV
C <sub>c</sub>	collector capacitance	$I_E = i_e = 0$ ; $V_{CB} = -12 \text{ V}$ ; $f = 1 \text{ MHz}$	_	2.2	pF
f <sub>T</sub>	transition frequency	$I_C = -2 \text{ mA}; V_{CE} = -12 \text{ V}; f = 100 \text{ MHz}$	100	_	MHz

#### Note

1. Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

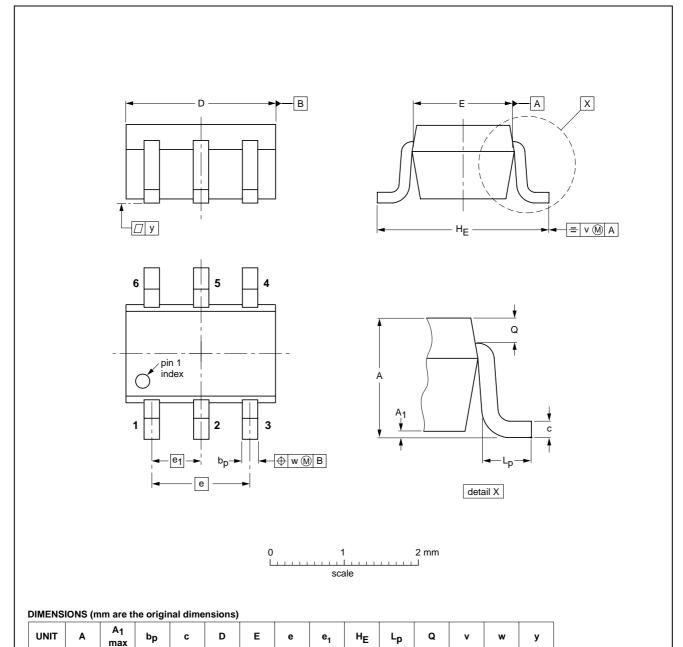
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#### **PACKAGE OUTLINE**

Plastic surface mounted package; 6 leads

**SOT363** 



OUTLINE	REFERENCES			EUROPEAN	ICCUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT363			SC-88			97-02-28

0.65

0.45 0.15 0.25 0.15

0.2

0.1

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0.25 0.10

0.30

0.20

1.1 0.8

mm

0.1

2.2 1.8 1.35 1.15

1.3

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#### **DATA SHEET STATUS**

DATA SHEET STATUS(1)	PRODUCT STATUS <sup>(2)</sup>	DEFINITIONS
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# PNP general purpose double transistor

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**NOTES** 

# PNP general purpose double transistor

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**NOTES** 

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